MOSFET – Power, N-Channel, SUPERFET III, FRFET

650 V, 20 A, 190 m Ω

NTHL190N65S3HF

Description

SUPERFET III MOSFET is ON Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This advanced technology is tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt rate.

Consequently, SUPERFET III MOSFET is very suitable for the various power system for miniaturization and higher efficiency.

SUPERFET III FRFET MOSFET's optimized reverse recovery performance of body diode can remove additional component and improve system reliability.

Features

- 700 V @ $T_J = 150^{\circ}C$
- Typ. $R_{DS(on)} = 165 \text{ m}\Omega$
- Ultra Low Gate Charge (Typ. Q_g = 34 nC)
- Low Effective Output Capacitance (Typ. Coss(eff.) = 316 pF)
- 100% Avalanche Tested
- These Devices are Pb-Free and are RoHS Compliant

Applications

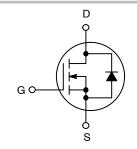
- Telecom / Server Power Supplies
- Industrial Power Supplies
- EV Charger
- UPS / Solar



ON Semiconductor®

www.onsemi.com

| V _{DSS} | R _{DS(on)} MAX | I _D MAX |
|------------------|-------------------------|--------------------|
| 650 V | 190 m Ω @ 10 V | 20 A |

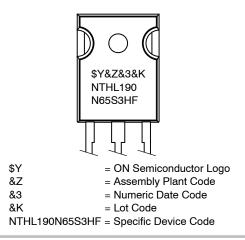


N-Channel MOSFET



TO-247-3LD CASE 340CX

MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

| Symbol | Para | Value | Unit | | |
|-----------------------------------|--|-------------------------------------|-------------|------|--|
| V _{DSS} | Drain to Source Voltage | 650 | V | | |
| V _{GSS} | Gate to Source Voltage | DC | ±30 | V | |
| | | AC (f > 1 Hz) | ±30 | V | |
| ID | Drain Current | Continuous (T _C = 25°C) | 20 | A | |
| | | Continuous (T _C = 100°C) | 12.7 | | |
| I _{DM} | Drain Current | Pulsed (Note 1) | 50 | А | |
| E _{AS} | Single Pulsed Avalanche Energy (Note 2) | | 220 | mJ | |
| I _{AS} | Avalanche Current (Note 2) | | 3.7 | A | |
| E _{AR} | Repetitive Avalanche Energy (Note 1) | | 1.62 | mJ | |
| dv/dt | MOSFET dv/dt | | 100 | V/ns | |
| | Peak Diode Recovery dv/dt (Note 3) | | 50 | | |
| PD | Power Dissipation | (T _C = 25°C) | 162 | W | |
| | | Derate Above 25°C | 1.3 | W/°C | |
| T _J , T _{STG} | Operating and Storage Temperature Range | | -55 to +150 | °C | |
| ΤL | Maximum Lead Temperature for Soldering, 1/8" from Case for 5 s | | 300 | °C | |

ABSOLUTE MAXIMUM RATINGS (T_C = 25°C, Unless otherwise specified)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1. Repetitive rating: pulse-width limited by maximum junction temperature. 2. $I_{AS} = 3.7 \text{ A}, R_G = 25 \Omega$, starting $T_J = 25^{\circ}\text{C}$. 3. $I_{SD} \le 10 \text{ A}, \text{ di/dt} \le 200 \text{ A/}\mu\text{s}, \text{V}_{DD} \le 400 \text{ V}$, starting $T_J = 25^{\circ}\text{C}$.

THERMAL CHARACTERISTICS

| Symbol | Parameter | Value | Unit |
|---------------------|---|-------|------|
| $R_{	ext{	heta}JC}$ | Thermal Resistance, Junction to Case, Max. | 0.77 | °C/W |
| R _{θJA} | Thermal Resistance, Junction to Ambient, Max. | 40 | |

PACKAGE MARKING AND ORDERING INFORMATION

| Part Number | Top Marking | Package | Packing Method | Reel Size | Tape Width | Quantity |
|----------------|----------------|---------|----------------|-----------|------------|----------|
| NTHL190N65S3HF | NTHL190N65S3HF | TO-247 | Tube | N/A | N/A | 30 Units |

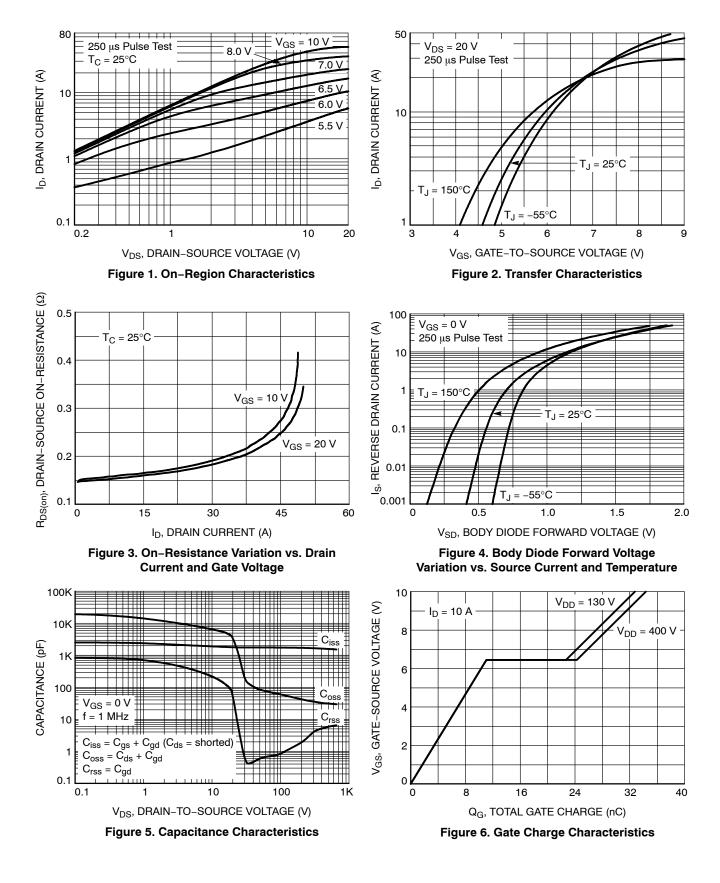
ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

| Symbol | Parameter | Test Conditions | Min | Тур | Max | Unit |
|--|--|---|-----|------|------|------|
| FF CHARACT | ERISTICS | | • | | | |
| BV _{DSS} | Drain to Source Breakdown Voltage | V_{GS} = 0 V, I_D = 1 mA, T_J = 25°C | 650 | | | V |
| | | V_{GS} = 0 V, I _D = 1 mA, T _J = 150°C | 700 | | | V |
| $\Delta \text{BV}_{\text{DSS}} / \Delta \text{T}_{\text{J}}$ | Breakdown Voltage Temperature Coefficient | $I_D = 10$ mA, Referenced to 25°C | | 0.65 | | V/°C |
| I _{DSS} | Zero Gate Voltage Drain Current | V_{DS} = 650 V, V_{GS} = 0 V | | | 10 | μΑ |
| | | V_{DS} = 520 V, T_C = 125 °C | | 65 | | |
| I _{GSS} | Gate to Body Leakage Current | V_{GS} = ± 30 V, V_{DS} = 0 V | | | ±100 | nA |
| N CHARACTE | ERISTICS | | | | | |
| V _{GS(th)} | Gate Threshold Voltage | $V_{GS} = V_{DS}$, $I_D = 0.43$ mA | 3.0 | | 5.0 | V |
| R _{DS(on)} | Static Drain to Source On Resistance | V_{GS} = 10 V, I _D = 10 A | | 165 | 190 | mΩ |
| 9 _{FS} | Forward Transconductance | $V_{DS} = 20 \text{ V}, \text{ I}_{D} = 10 \text{ A}$ | | 11 | | S |
| YNAMIC CHA | RACTERISTICS | | • | | | • |
| C _{iss} | Input Capacitance | V _{DS} = 400 V, V _{GS} = 0 V, f = 1 MHz | | 1610 | | pF |
| C _{oss} | Output Capacitance | | | 30 | | pF |
| C _{oss(eff.)} | Effective Output Capacitance | V_{DS} = 0 V to 400 V, V_{GS} = 0 V | | 316 | | pF |
| C _{oss(er.)} | Energy Related Output Capacitance | V_{DS} = 0 V to 400 V, V_{GS} = 0 V | | 59 | | pF |
| Q _{g(tot)} | Total Gate Charge at 10 V | | | 34 | | nC |
| Q _{gs} | Gate to Source Gate Charge | V _{DS} = 400 V, I _D = 10 A, V _{GS} = 10 V (Note 4) | | 11 | | nC |
| Q _{gd} | Gate to Drain "Miller" Charge | | | 13 | | nC |
| ESR | Equivalent Series Resistance | f = 1 MHz | | 6.8 | | Ω |
| WITCHING CH | IARACTERISTICS | | • | | | • |
| t _{d(on)} | Turn-On Delay Time | V _{DD} = 400 V, I _D = 10 A, V _{GS} = 10 V, R _g = 4.7 Ω (Note 4) | | 19 | | ns |
| t _r | Turn-On Rise Time | | | 19 | | ns |
| t _{d(off)} | Turn-Off Delay Time | | | 58 | | ns |
| a(e) | | | H | 14 | 1 | 1 |

| ۱ _S | Maximum Continuous Source to Drain Diode Forward Current | | | 20 | А | |
|-----------------|--|--|--|-----|-----|----|
| I _{SM} | Maximum Pulsed Source to Drain Diode Forward Current | | | | 50 | А |
| V _{SD} | Source to Drain Diode Forward Voltage | V_{GS} = 0 V, I _{SD} = 10 A | | | 1.3 | V |
| t _{rr} | Reverse Recovery Time | V _{DD} = 400 V, I _{SD} = 10 A, | | 80 | | ns |
| Q _{rr} | Reverse Recovery Charge | dl _F /dt = 100 A/μs | | 264 | | nC |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Essentially independent of operating temperature typical characteristics.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

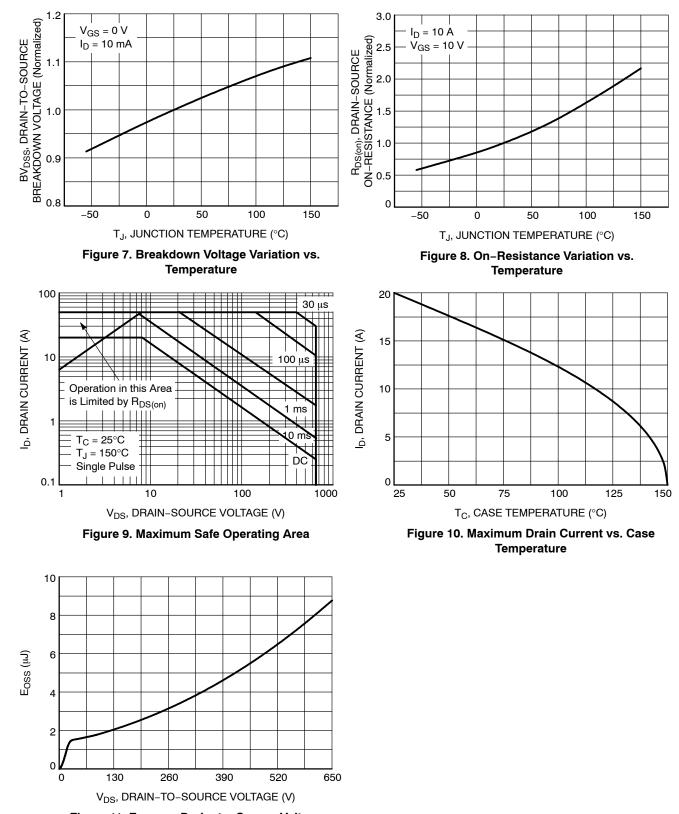


Figure 11. E_{OSS} vs. Drain-to-Source Voltage

TYPICAL CHARACTERISTICS

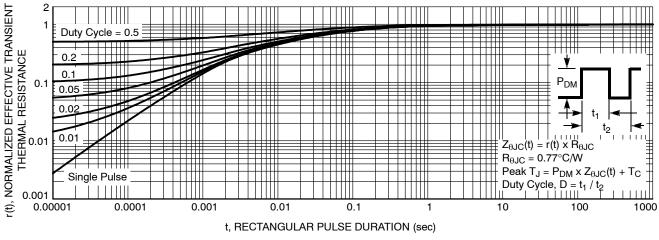
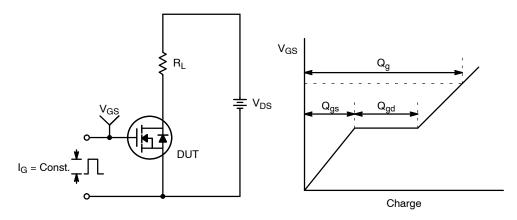


Figure 12. Transient Thermal Response Curve





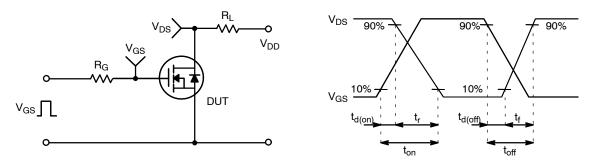
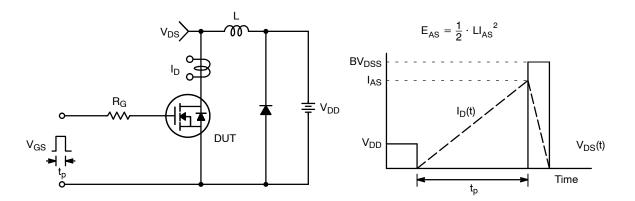


Figure 14. Resistive Switching Test Circuit & Waveforms





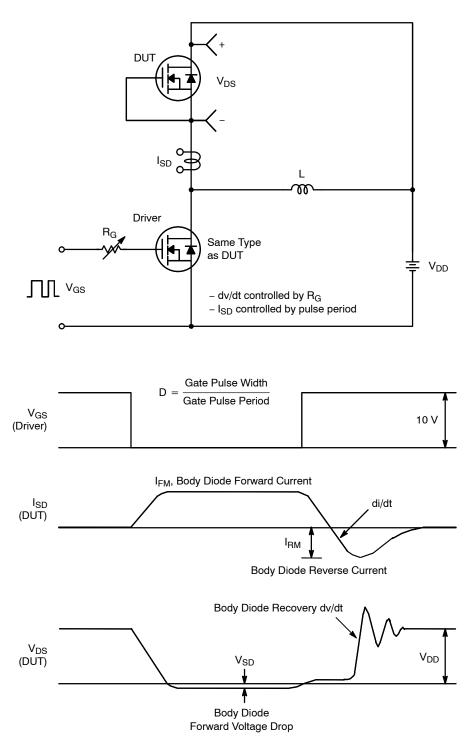
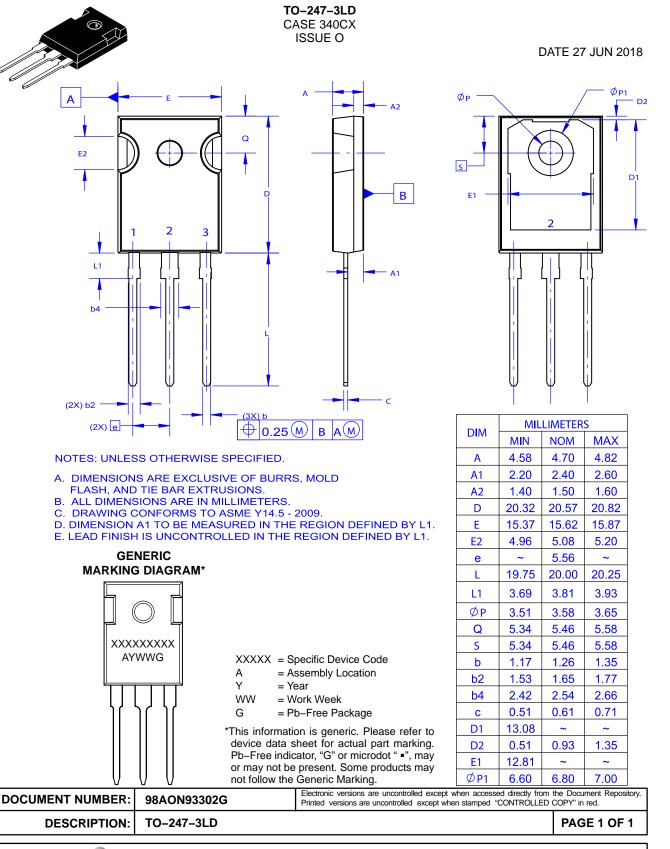


Figure 16. Peak Diode Recovery dv/dt Test Circuit & Waveforms

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